# UM10609 BGA7350 performance at IF=140 MHz Rev. 1 — 14 November 2012

**User manual** 

### **Document information**

Info	Content
Keywords	Dual VGA. 28 dB attenuator range IF=140 MHz NXP
Abstract	This User Manual describes the functionality and performance of the single ended BGA7350 evaluation board, tuned for a IF of 140 MHz



### BGA7350 performance at IF=140 MHz

### **Revision history**

Rev	Date	Description
1	20121114	First publication

# **Contact information**

For more information, please visit: <a href="http://www.nxp.com">http://www.nxp.com</a>

For sales office addresses, please send an email to: <a href="mailto:salesaddresses@nxp.com">salesaddresses@nxp.com</a>

### BGA7350 performance at IF=140 MHz

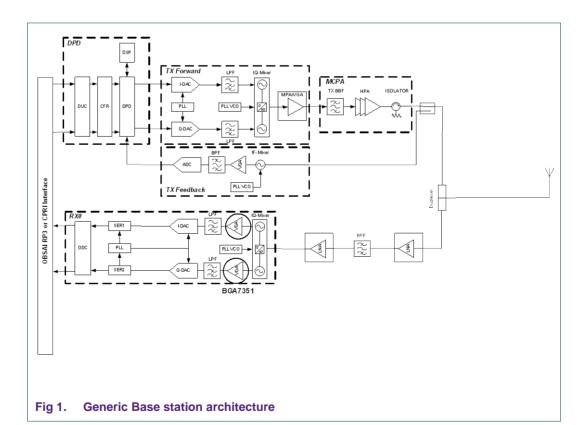
### 1. Introduction

The BGA7350 is a Silicon MMIC (Monolithic Microwave Integrated Circuit) processed in NXP's mainstream Si QuBIC4+ BiCmos process. This process intrinsic inhibits high  $F_T$  figures (up to 28 GHz), while not compromising ruggedness (breakdown voltage) and noise figures. These characteristics make this device suitable for versatile IF applications like in Base station receive path. The BGA7350 exhibits a logic-level shutdown control to reduce supply current. The BGA7350 is packed in the leadless HVQFN (5 x 5 mm²), and in combination with the optimized die design, gives excellent thermal performance,

To ensure optimal ESD protections, all pins are ESD protected.

All above mentioned highlight makes the BGA7350 and extreme attractive device with optimal performance/cost ratio, as compared to other devices in the market.

The single ended 140 MHz evaluation board (EVB) is designed for optimal performance in the 140 MHz frequency ranges, with a bandwidth of 28 MHz, suitable for base station Rx applications, as shown in Fig. 1.



### BGA7350 performance at IF=140 MHz

### 2. Product Profile

### 2.1 General description

The BGA7350 MMIC is a dual independently digitally controlled IF Variable Gain Amplifier (VGA) operating from 50 MHz to 250 MHz Each IF VGA amplifies with a gain range of 24 dB and at its maximum gain setting delivers 17 dBm output power at 1 dB gain compression and a superior linear performance.

The BGA7350 Dual IF VGA is optimized for a differential gain error of less than  $\pm 0.1$  dB for accurate gain control and has a total integrated gain error of less than  $\pm 0.3$  dB.

The gain controls of each amplifier are separate digital gain-control word, which is provided externally through two sets of 5 bits.

The BGA7350 is housed in a 32 pins  $5 \times 5$  mm2 leadless HVQFN package.

### 2.2 Features and benefits

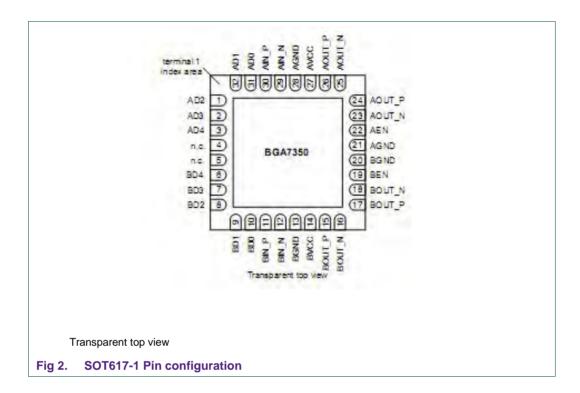
- Dual independent digitally controlled 28 dB gain range VGAs, with 5-bit control interface
- 50 MHz to 250 MHz frequency operating range
- Gain step size: 1 dB ± 0.1 dB
- 18.5 dB small signal gain
- Fast gain stage switching capability
- 17 dBm output power at 1 dB gain compression
- 5 V single supply operation with power-down control
- Logic-level shutdown control pin reduces supply current
- Excellent ESD protection at all pins
- Moisture sensitivity level 2
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)
- Unconditionally stable
- Excellent differential and integrated gain error

### 2.3 Applications

- Compatible with GSM / W-CDMA carrier/ WiMAX / LTE base-station infrastructure / multi systems carrier
- Multi channel receivers
- General use for DAC driver applications

### BGA7350 performance at IF=140 MHz

# 3. Pinning information



### BGA7350 performance at IF=140 MHz

# 3.1 Pin description

Table 2. Pin description

Table 2.	Pin description	
Symbol	Pin	Description
AD2	1	MSB – 2 for gain control interface of channel A
AD3	2	MSB – 1 for gain control interface of channel A
AD4	3	MSB for gain control interface of channel A
n.c.	4	not connected [1]
n.c.	5	not connected [1]
BD4	6	MSB for gain control interface of channel B
BD3	7	MSB – 1 for gain control interface of channel B
BD2	8	MSB – 2 for gain control interface of channel B
BD1	9	LSB + 1 for gain control interface of channel B
BD0	10	LSB for gain control interface of channel B
BIN_P	11	channel B positive input [2]
BIN_N	12	channel B negative input [2]
GNDB	13, 20	ground for channel B
V <sub>CCB</sub>	14	supply voltage for channel B [3]
BOUT_P	15, 17	channel B positive output [2]
BOUT_N	16, 18	channel B negative output [2]
BEN	19	power enable pin for channel B
GNDA	21, 28	ground for channel A
AEN	22	power enable pin for channel A
AOUT_N	23, 25	channel A negative output [2]
AOUT_P	24, 26	channel A positive output [2]
VCCA	27	supply voltage for channel A [3]
AIN_N	29	channel A negative input [2]
AIN_P	30	channel A positive input [2]
AD0	31	LSB for gain control interface of channel A
AD1	32	LSB + 1 for gain control interface of channel A
GND	GND paddle	RF ground and DC ground [4]

<sup>[1]</sup> Pin to be left open.

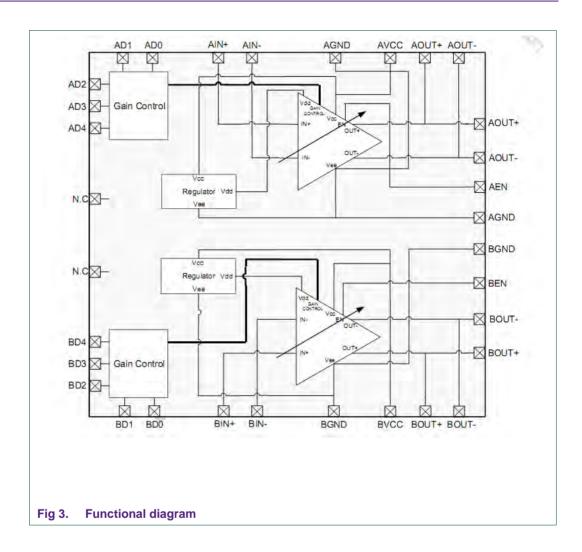
<sup>[2]</sup> Each channel should be independently enabled with logic HIGH and disabled with logic LOW.

<sup>[3]</sup> RF decoupled.

<sup>[4]</sup> The center metal base of the SOT617-1 also functions as heatsink for the VGA.

### BGA7350 performance at IF=140 MHz

# 4. Functional Diagram



### BGA7350 performance at IF=140 MHz

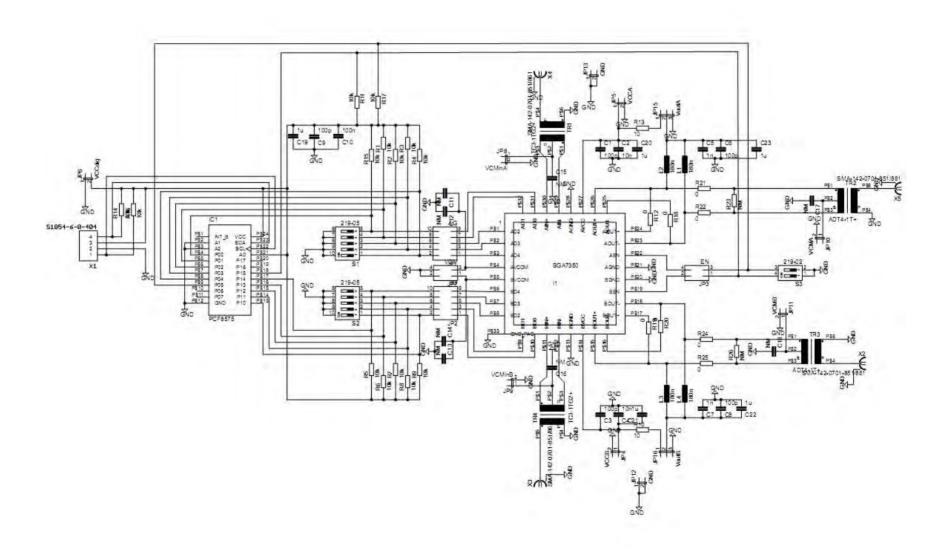
# 5. Gain control Range

Input to all 0 to 4 gain control pins	nominal power gain [dB]
00000	22
00001	21
00010	20
00011	19
00100	18
00101	17
00110	16
00111	15
01000	14
01001	13
01010	12
01011	11
01100	10
01101	9
01110	8
01111	7
10000	6
10001	5
10010	4
10011	3
10100	2
10101	1
10110	0
10111	-1
11000	-2
11001	-3
11010	-4
11011	<b>-</b> 5
11100	-6
> 11100	-6

Table 3 Gain control range

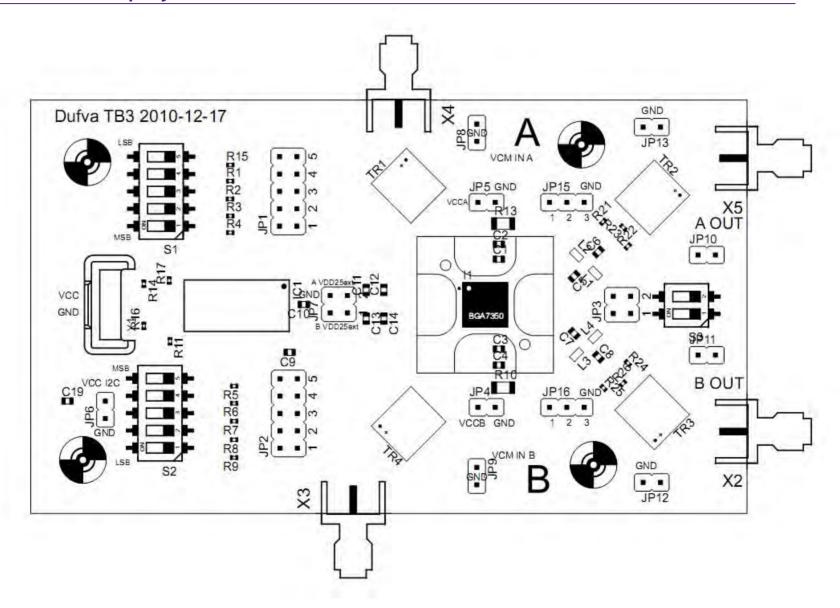
### **BGA7350** performance at IF=140 MHz

# 6. EVB circuit diagram



### BGA7350 performance at IF=140 MHz

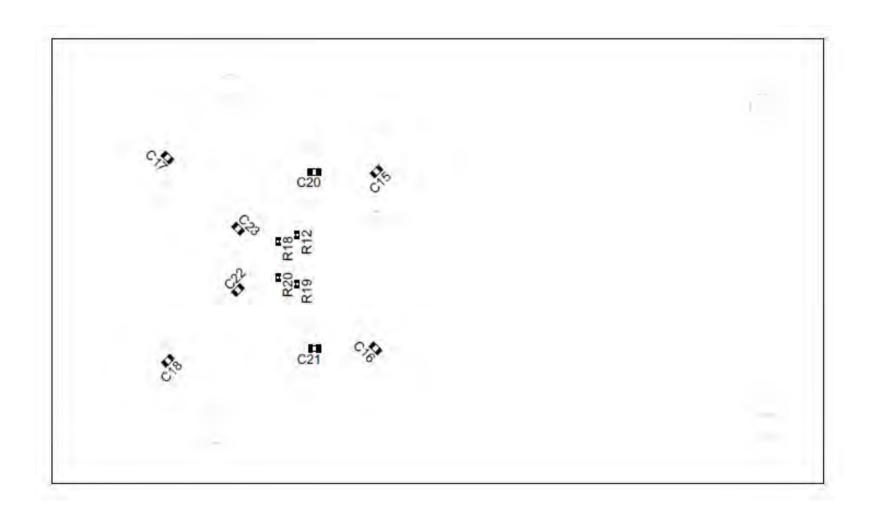
# 7. Evaluation Board top layout



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# 8. Evaluation board bottom layout



**User manual** 

11 of 40

# BGA7350 performance at IF=140 MHz

# 9. Bill of Materials (BOM)

Part	Value	Device	Package	Description
C1	100p		C0603	CAPACITOR
C2	10n		C0603	CAPACITOR
СЗ	100p		C0603	CAPACITOR
C4	10n		C0603	CAPACITOR
C5	1n		C0603	CAPACITOR
C6	100p		C0603	CAPACITOR
C7	1n		C0603	CAPACITOR
C8	100p		C0603	CAPACITOR
C9	100p		C0603	CAPACITOR
C10	100n		C0603	CAPACITOR
C11	NM		C0603	CAPACITOR
C12	NM		C0603	CAPACITOR
C13	NM		C0603	CAPACITOR
C14	NM		C0603	CAPACITOR
C15	100n		C0603	CAPACITOR
C16	100n		C0603	CAPACITOR
C17	100n		C0603	CAPACITOR
C18	100n		C0603	CAPACITOR
C19	100n		C0603	CAPACITOR
C20	100n		C0603	CAPACITOR
C25	1u		C0603	CAPACITOR
C26	1u		C0603	CAPACITOR
C27	1u		C0603	CAPACITOR
C28	1u		C0603	CAPACITOR
C29	1u		C0603	CAPACITOR
-	.,		3333	0.1.1.1011.011
11	BGA7350		SOT617-1	BGA7350
			001017-1	DGW/ 330
	BOAR 330		301017-1	D9A7330
JP1	AG	2 x 5pins	JP5	JUMPER
JP2	AG BG	2 x 5pins	JP5 JP5	JUMPER JUMPER
JP2 JP3	AG BG EN	2 x 5pins 2 x 2pins	JP5 JP5 JP2	JUMPER JUMPER JUMPER
JP2 JP3 JP4	AG BG EN VCCB	2 x 5pins 2 x 2pins 1 x2pins	JP5 JP5 JP2 JP1	JUMPER JUMPER JUMPER JUMPER
JP2 JP3 JP4 JP5	AG BG EN VCCB VCCA	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1	JUMPER JUMPER JUMPER JUMPER JUMPER
JP2 JP3 JP4 JP5 JP6	AG BG EN VCCB VCCA VCCdig	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP1	JUMPER JUMPER JUMPER JUMPER JUMPER JUMPER JUMPER
JP2 JP3 JP4 JP5 JP6 JP7	AG BG EN VCCB VCCA VCCdig VCM	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2	JUMPER JUMPER JUMPER JUMPER JUMPER JUMPER JUMPER JUMPER JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8	AG BG EN VCCB VCCA VCCdig VCM VCMinA	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP2	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 1 x2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1 JP1 JP1 JP1 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 1 x2pins 1 x2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1 JP1 JP1 JP1 JP1 JP1 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1 JP1 JP1 JP1 JP1 JP1 JP1 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12 JP13	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12 JP13 JP15	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND GND VoutA	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP2 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12 JP13	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12 JP13 JP15 JP16	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND GND VoutA VoutB	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins 1 x3pins 1 x3pins	JP5 JP5 JP2 JP1 JP1 JP2 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12 JP13 JP15 JP16	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND GND VoutA VoutB	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins 1 x3pins 1 x3pins	JP5 JP5 JP2 JP1	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12 JP13 JP15 JP16	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND GND VoutA VoutB	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins 1 x3pins 1 x3pins 1 x3pins 1 x3pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1 JP1 JP1 JP1 JP1 JP1 JP1 JP1 JP3 JP3 JP3	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12 JP13 JP15 JP16 L1 L2 L3	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND GND VoutA VoutB	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins 1 x3pins 1 x3pins 1 x3pins 1 x3pins 1 x3pins 0603LS 0603LS	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1 JP1 JP1 JP1 JP1 JP1 JP1 JP1 JP3 JP3 JP3 O603LS O603LS	JUMPER
JP2 JP3 JP4 JP5 JP6 JP7 JP8 JP9 JP10 JP11 JP12 JP13 JP15 JP16	AG BG EN VCCB VCCA VCCdig VCM VCMinA VCMinB VCMA VCMB GND GND VoutA VoutB	2 x 5pins 2 x 2pins 1 x2pins 1 x2pins 1 x2pins 2 x 2pins 1 x2pins 1 x3pins 1 x3pins 1 x3pins 1 x3pins	JP5 JP5 JP2 JP1 JP1 JP1 JP2 JP1 JP1 JP1 JP1 JP1 JP1 JP1 JP1 JP3 JP3 JP3	JUMPER

# BGA7350 performance at IF=140 MHz

Part	Value	Device	Package	Description
Part  R1 R2 R3 R4 R5 R6 R7 R8 R9 R10 R11 R12 R13 R14 R15 R16 R17 R18 R20 R21 R22 R23 R24 R25 R26 R27 R28 R29 R30 R31 R32 R33 R34	Value  10k 10k 10k 10k 10k 10k 10k 10k 10 10k 10 10k 10k	R-EU_R0402	R0402 R1206 R0402	RESISTOR
R37 R38 S1 S2 S3	NM 0 DIP DIP DIP	R-EU_R0402 R-EU_R0402 219-05 219-05 219-02	R0402 R0402 CTS-219-05 CTS-219-05 CTS-219-02	RESISTOR RESISTOR Surface Surface Surface
TR1 TR2 TR3 TR9	ADT3-1T+ ADT4-1T+ ADT4-1T+ ADT3-1T+	transformer transformer transformer transformer		Mini-Circuits Mini-Circuits Mini-Circuits Mini-Circuits
X1 X2 X3 X4 X5 X10 X11 X12 X13 X14	NM BOUT_P BIN_P AIN_P AOUT_P NM NM NM NM NM NM	con SMA connector SMA connector SMA connector SMA connector BU-SMA-V SMA connector SMA connector SMA connector SMA connector SMA connector SMA connector		SMA SMA SMA SMA FEMALE SMA SMA SMA FEMALE SMA

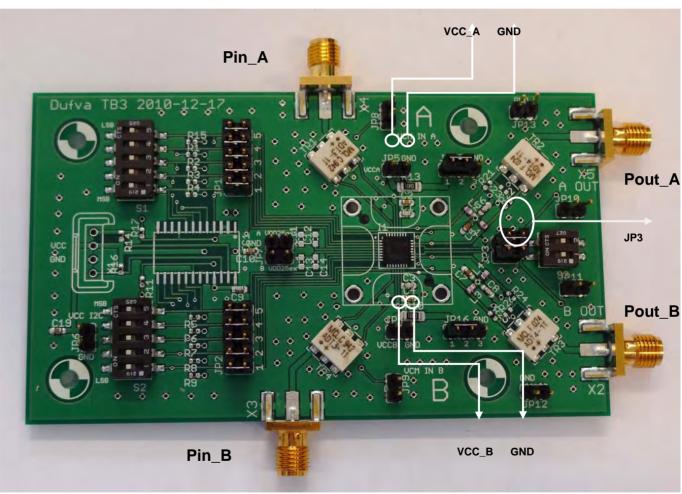
### BGA7350 performance at IF=140 MHz

# 10. Operation of the BGA7350 EVB

# 10.1 Applying bias

The EVB, as shown in Fig. 4, should be connected to 5V supply, according the following connections:

- 1. Leave jumpers JP3 in their current position, as shown in Fig. 4
- 2. Apply +5V to VCC\_A and/or VCC\_B to the pins, as shown in Fig. 4
- 3. Apply ground to GND\_A and/or GND\_B pins



26.

Fig 4. BGA7350 EVB picture

### BGA7350 performance at IF=140 MHz

### 10.2 Mode of operation

The EVB of the BGA7350 can either be operated in the manual mode or 'automatic' mode. The BGA7350 can be enabled/disabled by switch3 (see Fig.5)

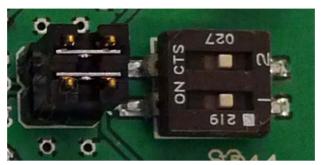


Fig 5. Enable/disable switch S3

### 10.2.1 Manual mode.

For manual mode operation, all jumpers, as shown in Fig. 5 must be in place. Also a 5V pull-up voltage and ground should be applied, as indicated as 5V/GND pull-up in Fig. 6.

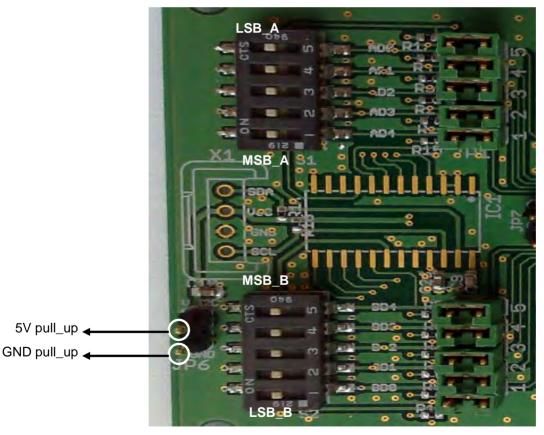


Fig. 6 Manual gain settings by switches S1 and S2

With the positions of S1 and S2, the gain range can be adjusted according the values in Table.3.

### BGA7350 performance at IF=140 MHz

### 10.3 Mode of operation

The EVB of the BGA7350 can either be operated in the manual mode or 'automatic' mode. The BGA7350 can be enabled/disabled by switch3 (see Fig.5)

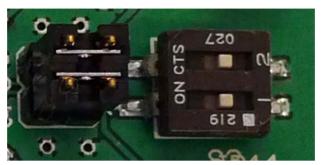


Fig 5. Enable/disable switch S3

### 10.3.1 Manual mode.

For manual mode operation, all jumpers, as shown in Fig. 5 must be in place. Also a 5V pull-up voltage and ground should be applied, as indicated as 5V/GND pull-up in Fig. 6.

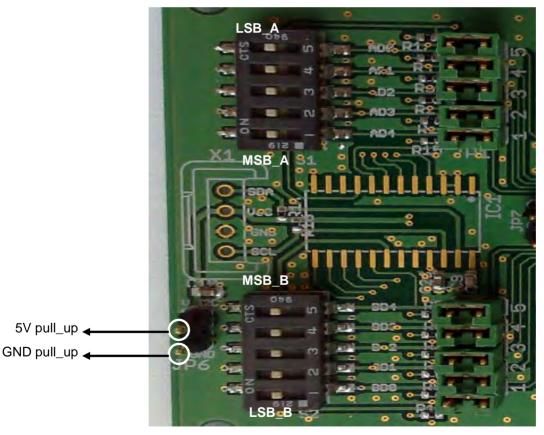


Fig. 6 Manual gain settings by switches S1 and S2

With the positions of S1 and S2, the gain range can be adjusted according the values in Table.3.

### BGA7350 performance at IF=140 MHz

### 10.3.2 'Automatic' mode

For 'automatic' mode of operations the jumpers according Fig. 6 should be removed, and logic levels should be applied to the rows (also I<sup>2</sup>C operation is possible, but not functional on this EVB), as indicated by the white circles (see Fig. 7). The logic levels applied to the pins should be within the following range:

0V < '0' < 0.8V

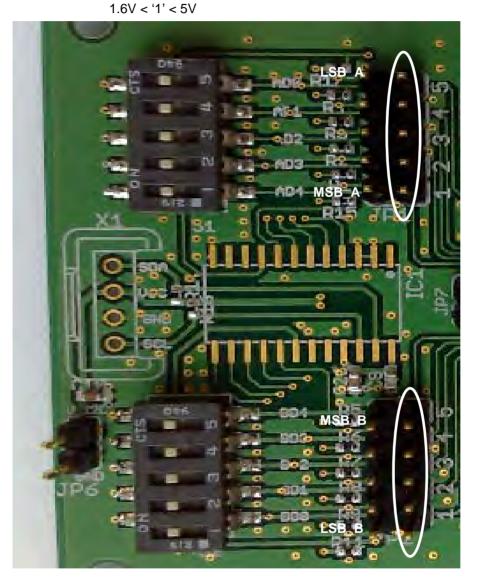


Fig. 7 Gain setting control by logic levels, according table 3

### BGA7350 performance at IF=140 MHz

# 11. Measurements

On the BGA7350, the following measurements have been performed:

1. S-parameters. From the S-parameter measurements the following data can be deducted:

a.	S-parameters	(Spar)
b.	Power gain	$(G_p)$
c.	Gain adjustment range	$(\Delta g_{adj})$
d.	Gain step	$(G_{step})$
e.	Gain Flatness	$(G_{\text{flat}})$
f.	Differential gain error	$(Eg_{diff})$
g.	Integrated gain error	$(Eg_{itg})$
h.	Isolation	(ISL)
i.	Output power at 1dB compression	$(P_{1dB})$

2. Harmonic Measurements. From the Harmonic measurements the following data can be deducted:

a. Output third order intercept point (IP3<sub>0</sub>)
 b. Second harmonic (H<sub>2</sub>)

- 3. Noise Measurements. From the Noise measurements the following data can be deducted:
  - a. Noise Figure (NF)
- 4. Timing measurement. From the Timing measurements the following data can be deducted:
  - a. Gain step settling time (min/max) (t<sub>s(step)G</sub>)

### BGA7350 performance at IF=140 MHz

### 11.1 Measurement definitions

### 11.1.1 Differential input and output impedance

```
|Zi| = |((1+S_{11}(F)) / (1-S_{11}(F)))| * 500hm, with F = 70MHz ... 210MHz
|Zo| = |((1+S_{22}(F)) / (1-S_{22}(F)))| * 500hm, with F = 70MHz ... 210MHz
```

### 11.1.2 Absolute gain accuracy

Absolute gain accuracy  $(140Mhz) = 20log(|S_{21}(140MHz)|) - 22dB$  (=typical max gain)

### 11.1.3 Gain flatness

```
Gain flatness (F) = Max (Gain(F + \frac{1}{2} Fd ... F - \frac{1}{2} Fd)) – Min (Gain(F + \frac{1}{2} Fd ... F - \frac{1}{2} Fd)) with Gain(F) = 20*log(|S_{21}(F)|)
```

### 11.1.4 Differential gain errors

```
Differential gain error = max | Gain(x) – Gain(x-1) – 1dB |, with Gain(x) = 20log(|S_{21}(x)|) measured at 140 MHz and x = gain setting (1...24)
```

Differential gain error (upper 12dB) = 
$$| Gain(0) - Gain(12) - 12dB |$$
, with  $Gain(x) = 20log(|S_{21}(x)|)$  measured at 140 MHz and x = gain setting

```
Differential gain error (full range) = | Gain(0) - Gain(24) - 24dB |, with Gain(x) = 20log(|S_{21}(x)|) measured at 140 MHz and x = gain setting
```

### 11.1.5 Differential phase errors

```
Differential phase error (consecutive gain steps) = \arg(S_{21}(x)) - \arg(S_{21}(x-1)) with x = gain setting (0...24), measured 140 MHz
```

```
Differential phase error (any two steps upper 12dB) = \max(\arg(S_{21}(x;x-12))) - \min(\arg(S_{21}(x;x-12)))
```

with x = gain setting, measured at 140 MHz

Differential phase error (any two steps) =  $max(arg(S_{21}(x))) - min(arg(S_{21}(x)))$ with x = gain setting (0...24), measured at 140 MHz

## BGA7350 performance at IF=140 MHz

### 11.1.6 OPI3

OIP3low = Po(
$$F_1$$
)+ ½ (Po( $F_1$ )-Po( $F_1$ -2MHz)), with  $F_1$ =140 MHz  $F_2$  =  $F_1$ +2MHz OIP3high = Po( $F_2$ )+ ½ (Po( $F_2$ )-Po( $F_2$ -2MHz)), with  $F_1$ =140 MHz  $F_2$  =  $F_1$ +2MHz OIP3 = Min (OIP3low, OIP3high)

### 11.1.7 H2

$$2^{nd}$$
 order harm (F) =  $20log(|S21(2*F)|) - 20log((|S21(F)|)$ 

### BGA7350 performance at IF=140 MHz

### 11.2 S-parameter measurements

The S-parameters (and the above mentioned derivative measurements) are measured with a full two-port calibrated network analyzer; over the frequency range 70 - 220 MHz. Also the output power compression point ( $P_{1dB}$ ) has been measured with the network analyzer. In the latter case, a calibrated power sweep has been performed, in order to obtain the  $P_{1dB}$ .

All gain and phase measurements have been performed with a constant output power of +5 dBm, meaning that for every 1 dB increase of attenuation, the input power also have to increase by +1 dBm.

The non-used port's of the dual VGA (channel A or B) has been terminated with a 50-Ohm load.

The isolation measurement (ISL) have been performed by injecting the signal to the input of channel A, and measuring the response at the output of channel B (and vice versa), with the remaining input and output terminated with 50 Ohm.

### 11.3 Harmonic measurements.

The harmonic measurements (OIP<sub>2</sub>, OIP<sub>3</sub> and H<sub>2</sub>) have been measured with a set-up, as described in Fig. 8.

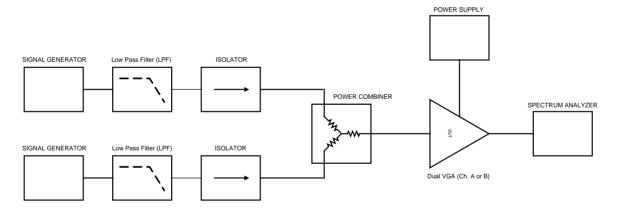


Fig. 8 Harmonic measurement set-up

A low-pass filter at the output of the signal generators guaranties suppression of the  $H_2$  generated by the generator itself.

### BGA7350 performance at IF=140 MHz

### 11.4 Noise Figure measurements

The Noise Figure (NF) has been measured with a noise source (Excess Noise Ratio ENR=15.3 dB), in combination with a spectrum analyzer with a noise measurement option. (See Fig.9)

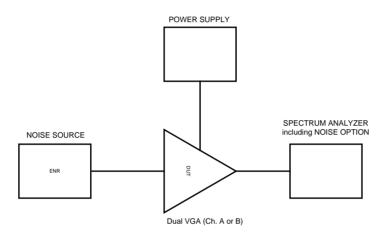


Fig. 9 Noise Figure Measurements

### 11.5 Timing Measurement.

In order to determine the gain step settling time, the set-up as shown in Fig. 10 has been used. A pulse generator (preferably a pulse generator that can supply the proper logic levels) is connected to the disable/enable pin of the EVB. The input (Pin\_A or Pin\_B) is connected to a signal generator (or network analyzer) to supply the RF input signal. The response (Pout\_A or Pout\_B) is measured with a digital sampling scope, triggered by the pulse generator. The 50-Ohm input of the sampling scope is used, in order to terminate the output of the dual VGA properly.

With the pulse generator, the gain settings are switch from minimum (00000) to maximum (11000) attenuation.

### BGA7350 performance at IF=140 MHz

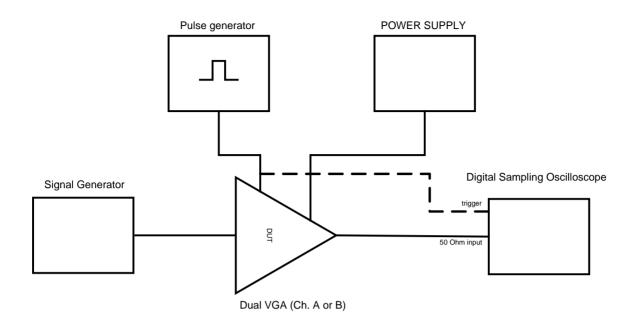


Fig. 10 Timing measurements

### 11.6 Measurement results

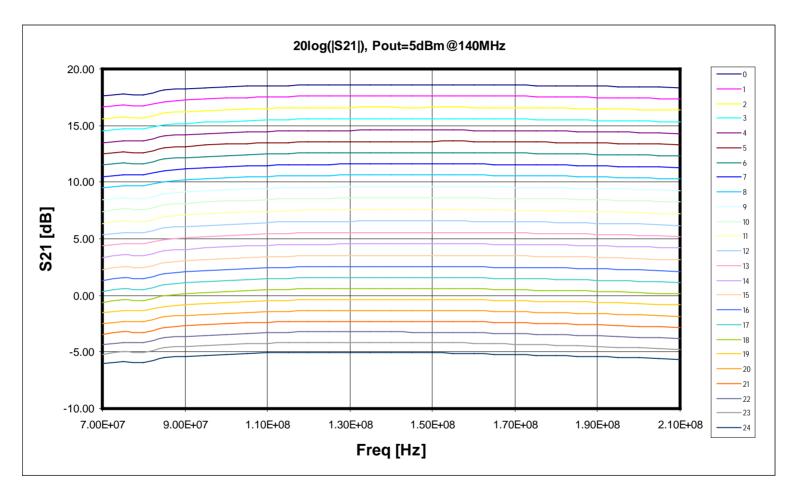
The section following below shows performance measurements of the BGA7350 EVB in single-ended operations.

The EVB has been measured under the following conditions:

- Measurement data corrected for input-and output transformer losses
- Input transformer; losses 0.55 dB, transformer ratio 1:3
- Output transformer; losses 0.6 dB, transformer ratio 1:4
- EVB optimized for 140 MHz operation (other frequency ranges can be easily optimized by changing L1 .. L4, see also circuit diagram.
- 5V supply
- 25 deg. Ambient temperature

### BGA7350 performance at IF=140 MHz

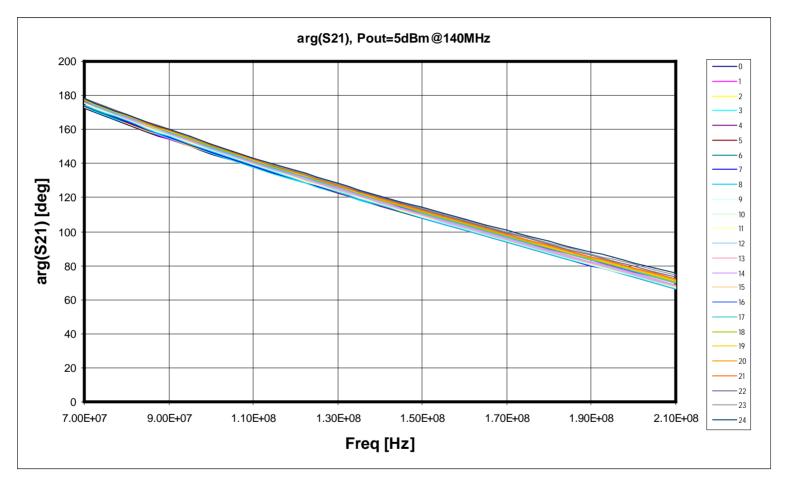
# 11.6.1 Gain as function of frequency and attenuator range



Note: every gain step measured @Pout= 5dBm

### **BGA7350** performance at IF=140 MHz

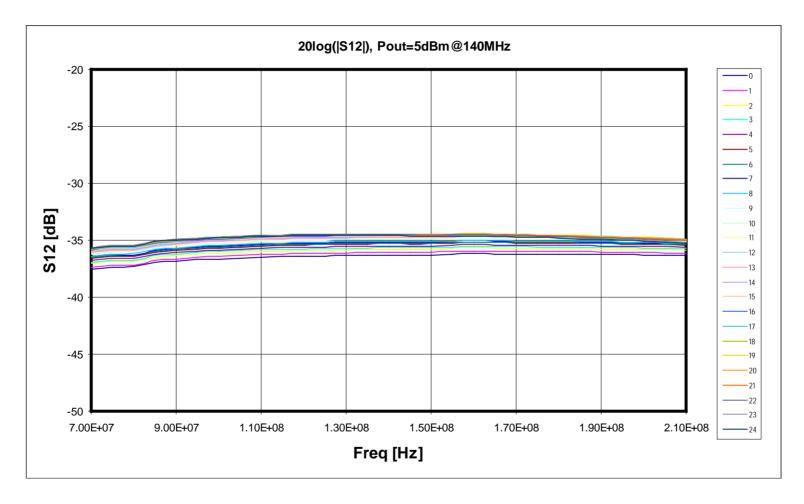
# 11.6.2 Phase of S21 as function of frequency and attenuator range



Note: every gain step measured @Pout= 5dBm

### **BGA7350** performance at IF=140 MHz

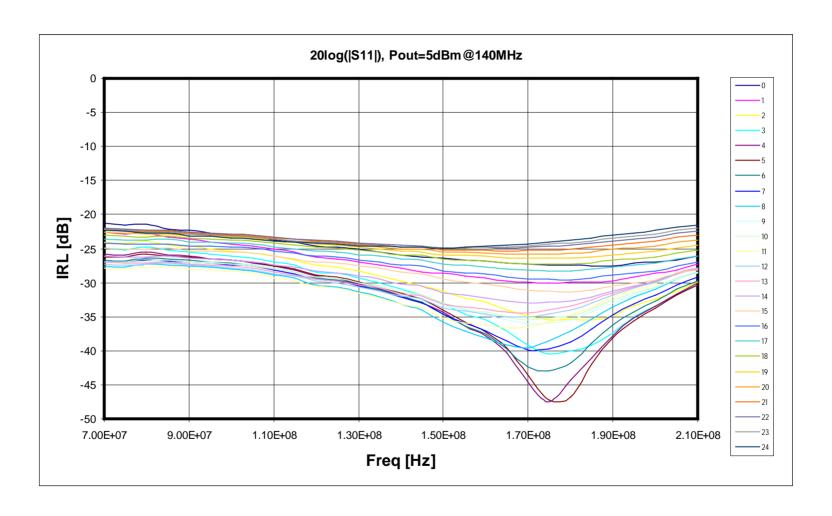
11.6.3 S-parameters; S12



Note: every gain step measured @Pout= 5dBm

### **BGA7350** performance at IF=140 MHz

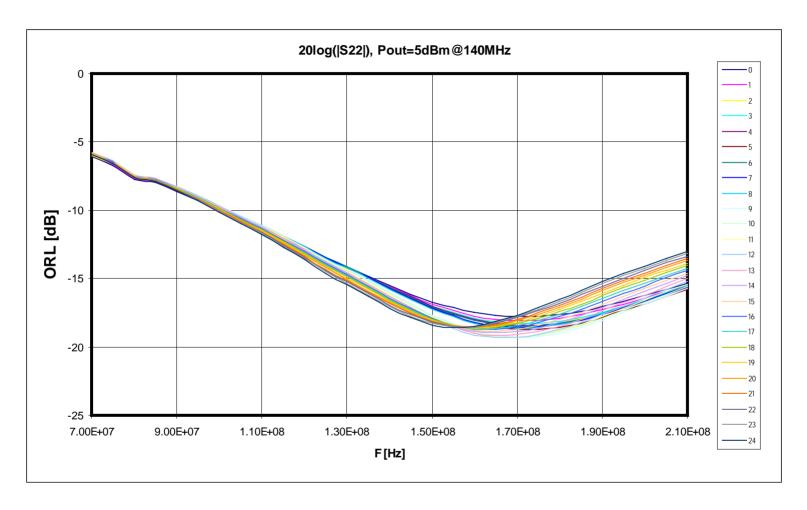
11.6.4 S-parameters; S11



Note: every gain step measured @Pout= 5dBm

### **BGA7350** performance at IF=140 MHz

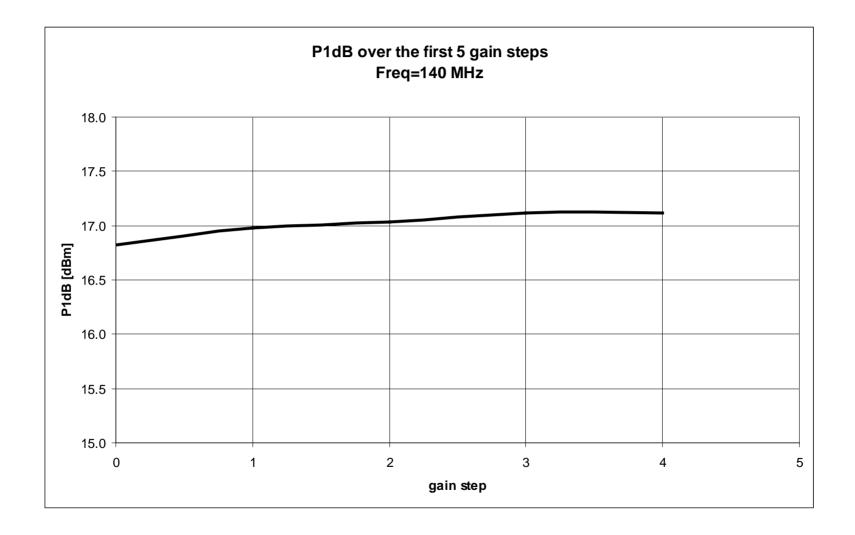
11.6.5 S-parameters; S22



Note: every gain step measured @Pout= 5dBm

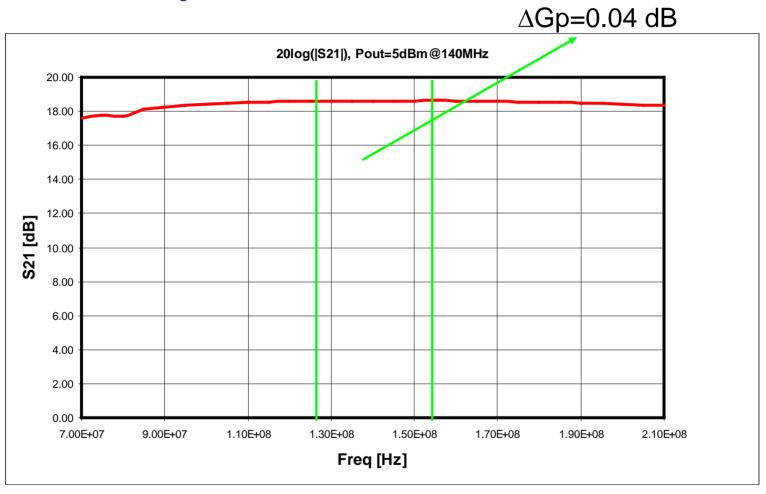
### **BGA7350** performance at IF=140 MHz

# 11.6.6 P1dB over first 5 gain steps



BGA7350 performance at IF=140 MHz

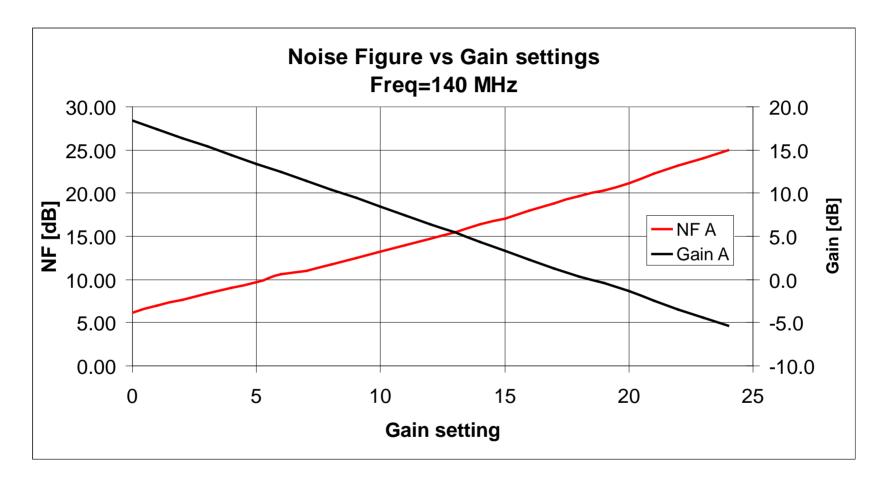
## 11.6.7 Gain Flatness @maximum gain



△Gp=0.04 dB over operating frequency band

BGA7350 performance at IF=140 MHz

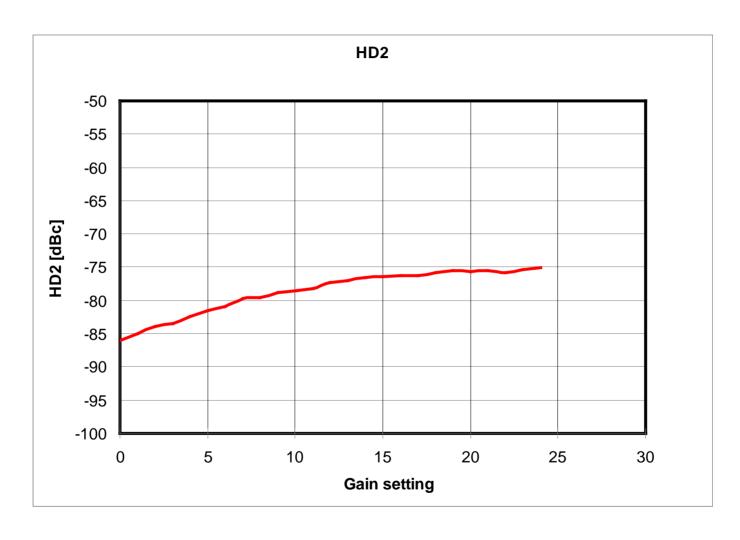
### 11.6.8 Noise Figure versus gain settings



Fmin=6.2 dB (@minimum attenuation, noise step = 0.8dB/dB

### **BGA7350** performance at IF=140 MHz

# 11.6.9 Harmonic Distortion (HD2) versus gain steps

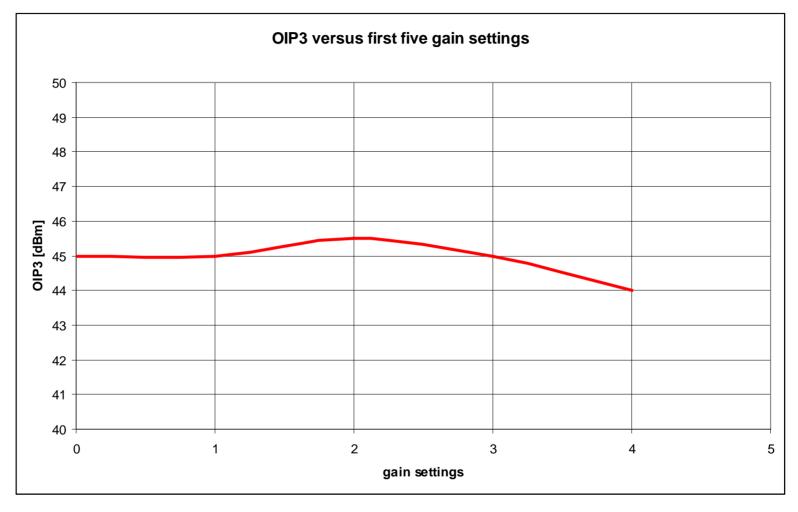


Note: Pout=+5 dBm for every gain step

Freq\_in=70 MHz

### **BGA7350** performance at IF=140 MHz

# 11.6.10 OIP3 over first 5 gain steps



Note: Pout per tone =+2 dBm

Freq1=140 MHz; Freq2= 142 MHz

### BGA7350 performance at IF=140 MHz

# 11.6.11 Summary of the gain errors

Measurement	Unit	Value	Conditions
Temperature	С	25 deg	
Power supply voltage	V	5	Definition
Power supply current	mA	122.3	Maximum supply current for all gain steps
Standby current	mA	2.61	Maximum standby current (for all gain steps)
Absolute gain	dB	19.06	Gain measured at F=140MHz, imcluding transformer losses
Differential gain error per 1dB consecutive steps	dB	0.11	Measured at F=140MHz
Integrated gain error upper 12dB	dB	0.05	Measured at F=140MHz
Integrated gain error full range	dB	-0.33	Measured at F=140MHz
Gain flatness over 30MHz bandwidth at maximum gain	dB	0.04	pk-pk over 30MHz bandwidth at gain=0
Gain flatness over 30MHz bandwidth at minimum gain	dB	0.08	pk-pk over 30MHz bandwidth at gain=24
Maximum gain flatness over 30MHz	dB	0.03	Maximum flatness over 30MHz for all gain steps
Minimum gain flatness over 30MHz	dB	0.16	Minimum flatness over 30MHz for all gain steps

### 11.6.12 Isolation (between channel A and channel B)

Gain settings @170 MHz	isolation [dB]
min	-59.8
max	-60

Measured @Pout=5dBm for both min and max gain

### 11.6.13 Impedance summary

Measurement	Unit	Value	Conditions
Maximum input impedance (BW=30 all gainsteps)	Ohm	54.5	Maximum absolute value measured over 30MHz bandwidth, for all gain steps
Minimum input impedance (BW=30 all gainsteps)	Ohm	45.4	Minimum absolute value measured over 30MHz bandwidth, for all gain steps
Maximum output impedance (BW=30 all gainsteps)	Ohm	53.6	Maximum absolute value measured over 30MHz bandwidth, for all gain steps
Minimum output impedance (BW=30 all gainsteps)	Ohm	45.5	Minimum absolute value measured over 30MHz bandwidth, for all gain steps
Maximum input impedance (BW=30 all gainsteps)	Ohm	54.3	Maximum real value measured over 30MHz bandwidth, for all gain steps
Minimum input impedance (BW=30 all gainsteps)	Ohm	45.3	Minimum real value measured over 30MHz bandwidth, for all gain steps
Maximum output impedance (BW=30 all gainsteps)	Ohm	49.5	Maximum real value measured over 30MHz bandwidth, for all gain steps
Minimum output impedance (BW=30 all gainsteps)	Ohm	44.5	Minimum real value measured over 30MHz bandwidth, for all gain steps

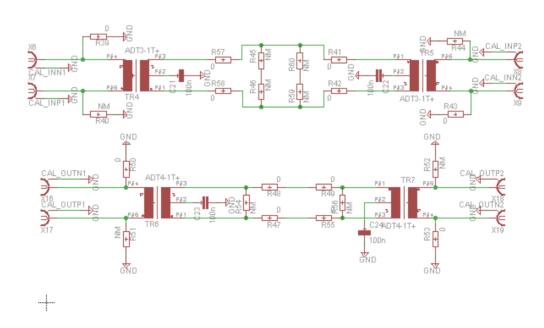
### BGA7350 performance at IF=140 MHz

### 12. Balun Characterization

In order to determine the BGA7350 performance only, the input-and output balun characteristics (losses) must be determined for correction. This has been done by measuring the baluns (both input and output) back-to-back, and assuming that both transformers are identical, the measured losses can be divided by two, to determine the losses per balun.

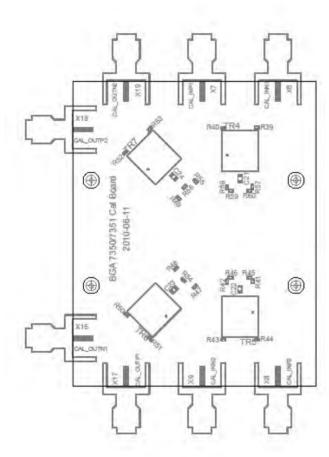
The measurements have been performed on the (calibration) boards, as described below)

### 12.1 Calibration EVB schematics



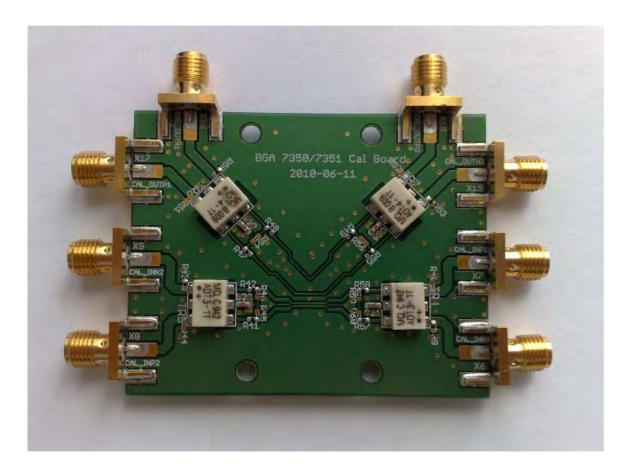
BGA7350 performance at IF=140 MHz

# 12.2 Calibration EVB layout



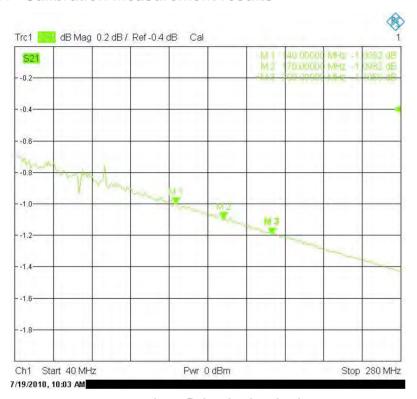
### **BGA7350** performance at IF=140 MHz

# 12.3 Calibration EVB picture



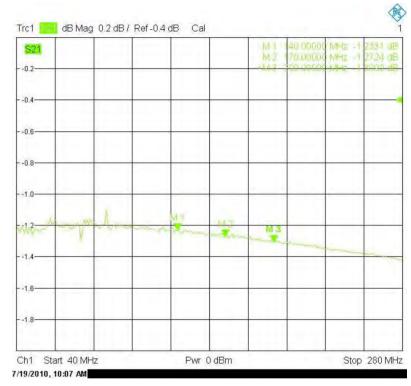
### **BGA7350** performance at IF=140 MHz

### 12.4 Calibration measurement results



Input Balun, back-to-back

The losses of the input balun is about 0.55 dB The losses of the output balun is about 0.6 dB



Output Balun, back-to back

### BGA7350 performance at IF=140 MHz

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### BGA7350 performance at IF=140 MHz

# 14. Contents

1.	Introduction	3
2.	Product Profile	4
2.1	General description	4
2.2	Features and benefits	4
2.3	Applications	
3.	Pinning information	5
3.1	Pin description	6
4.	Functional Diagram	7
5.	Gain control Range	8
6.	EVB circuit diagram	9
7.	Evaluation Board top layout	10
8.	Evaluation board bottom layout	11
9.	Bill of Materials (BOM)	12
10.	Operation of the BGA7350 EVB	14
10.1	Applying bias	14
10.2	Mode of operation	15
10.2.1	Manual mode	15
10.3	Mode of operation	16
10.3.1	Manual mode	
10.3.2	'Automatic' mode	17
11.	Measurements	18
11.1	Measurement definitions	19
11.1.1	Differential input and output impedance	19
11.1.2	Absolute gain accuracy	
11.1.3	Gain flatness	19
11.1.4	Differential gain errors	19
11.1.5	Differential phase errors	19
11.1.6	OPI3	20
11.1.7	H2	
11.2	S-parameter measurements	21
11.3	Harmonic measurements	21
11.4	Noise Figure measurements	
11.5	Timing Measurement	
11.6	Measurement results	23
11.6.1	Gain as function of frequency and attenuator	
	range	24
11.6.2	Phase of S21 as function of frequency and	
	attenuator range	
11.6.3	S-parameters; S12	
11.6.4	S-parameters; S11	
11.6.5	S-parameters; S22	
11.6.6	P1dB over first 5 gain steps	
11.6.7	Gain Flatness @maximum gain	
11.6.8	Noise Figure versus gain settings	31

11.6.9	Harmonic Distortion (HD2) versus gain steps	32
11.6.10	OIP3 over first 5 gain steps	33
11.6.11	Summary of the gain errors	34
11.6.12	Isolation (between channel A and channel B).	34
11.6.13	Impedance summary	34
12.	Balun Characterization	35
12.1	Calibration EVB schematics	35
12.2	Calibration EVB layout	36
12.3	Calibration EVB picture	37
12.4	Calibration measurement results	38
13.	Legal information	39
13.1	Definitions	39
13.2	Disclaimers	39
13.3	Licenses	39
13.4	Patents	39
13.5	Trademarks	39
14.	Contents	40

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